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Features

- Operating voltage: 2.4V~5.5V
- Internal 32kHz RC oscillator
- Bias: 1/2 or 1/3; Duty: 1/4
- Internal LCD bias generation with voltage-follower buffers
- I2C-bus interface
- Two Selectable LCD frame frequencies: 80Hz or 160Hz
- 44×4 bits RAM for display data storage
- Max. 44×4 patterns, 44 segments and 4 commons
- Versatile blinking modes
- · R/W address auto increment
- Internal 16-step voltage adjustment to adjust LCD operating voltage
- · Low power consumption
- Provides VLCD pin to adjust LCD operating voltage
- · Manufactured in silicon gate CMOS process
- Package Type: 48/52-pin LQFP, chip and COG

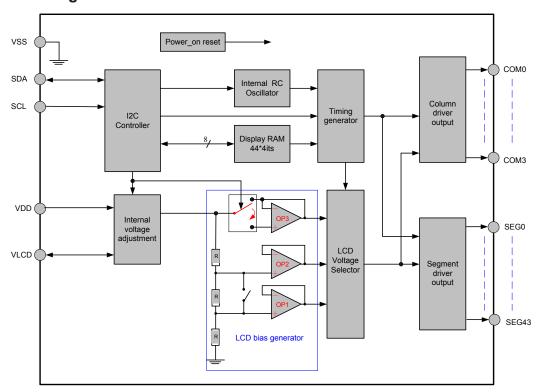
Applications

- · Electronic meter
- · Water meter
- · Gas meter
- · Heat energy meter
- · Household appliance
- Games
- Telephone
- · Consumer electronics

General Description

The HT16C22/HT16C22G device is a memory mapping and multi-function LCD controller driver. The maximum Display segments of the device are 176 patterns (44 segments and 4commons). The software configuration feature of the HT16C22/HT16C22G makes it suitable for multiple LCD applications including LCD modules and display subsystems. The HT16C22/HT16C22G device communicates with most microprocessors / microcontrollers via a two-line bidirectional I²C-bus.

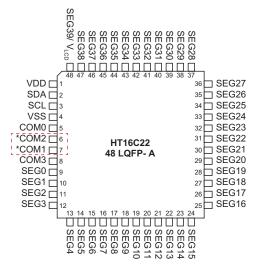
Block Diagram



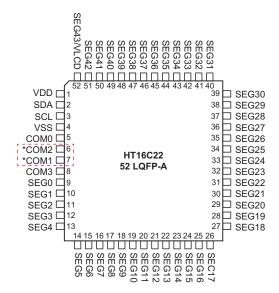
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Pin Assignment



Note: The *COM1 and *COM2 pins are not in sequential order.

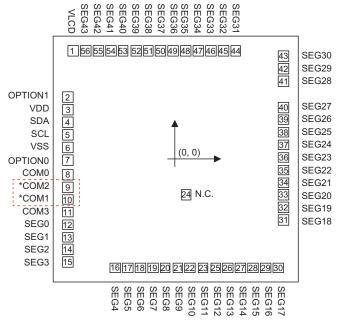


Note: The *COM1 and *COM2 pins are not in sequential order.

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Pad Assignment for COB



Chip size: $1673 \times 1676 um^2$

Note: 1. The Option0 (Pad7) should be bonded to V_{DD} or floating.

- 2. The Option1 (Pad2) should be bonded to $V_{\mbox{\scriptsize SS}}$ or floating.
- 3. The IC substrate should be connected to $V_{\mbox{\scriptsize SS}}$ in the PCB layout artwork
- 4. The *COM1 and *COM2 pins are not in sequential order.

| | ge Adjustment Command | VLCD (PAD4) | Segment43 | Note | | |
|--------|--------------------------|----------------|-----------|--|--|--|
| DE Bit | VE Bit | (PAD1) | (PAD56) | | | |
| 0 | 0 | Input | Null | The VLCD input voltage can be smaller than or equal to VDD | | |
| 0 | 1 | Output | Null | The VLCD pin is an output pin of which the voltage can be detected by the external MCU host. | | |
| 1 | 0 | Null | Output | _ | | |
| 1 | 1 | Null | Output | _ | | |

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Pad Coordinates for COB

unit: µm

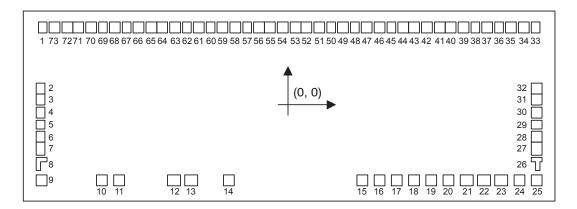
| No | Pad Name | Х | Y | No | Pad Name | Х | Υ |
|----|----------|---------|----------|----|----------|--------|---------|
| 1 | VLCD | -695.6 | 734.4 | 29 | SEG16 | 610.15 | -734.4 |
| 2 | Option1 | -732.9 | 421.349 | 30 | SEG17 | 695.15 | -734.4 |
| 3 | VDD | -732.9 | 336.349 | 31 | SEG18 | 732.45 | -411.35 |
| 4 | SDA | -732.9 | 251.349 | 32 | SEG19 | 732.45 | -326.35 |
| 5 | SCL | -732.9 | 166.349 | 33 | SEG20 | 732.45 | -241.35 |
| 6 | VSS | -732.9 | 81.349 | 34 | SEG21 | 732.45 | -156.35 |
| 7 | Option0 | -732.9 | -3.801 | 35 | SEG22 | 732.45 | -71.35 |
| 8 | COM0 | -732.9 | -102.1 | 36 | SEG23 | 732.45 | 13.65 |
| 9 | *COM2 | -732.9 | -187.1 | 37 | SEG24 | 732.45 | 98.65 |
| 10 | *COM1 | -732.9 | -272.1 | 38 | SEG25 | 732.45 | 183.65 |
| 11 | COM3 | -732.9 | -357.1 | 39 | SEG26 | 732.45 | 268.65 |
| 12 | SEG0 | -732.9 | -442.1 | 40 | SEG27 | 732.45 | 353.65 |
| 13 | SEG1 | -732.9 | -527.1 | 41 | SEG28 | 732.45 | 527.1 |
| 14 | SEG2 | -732.9 | -612.1 | 42 | SEG29 | 732.45 | 612.1 |
| 15 | SEG3 | -732.9 | -697.1 | 43 | SEG30 | 732.45 | 697.1 |
| 16 | SEG4 | -409.85 | -734.4 | 44 | SEG31 | 409.4 | 734.4 |
| 17 | SEG5 | -324.85 | -734.4 | 45 | SEG32 | 324.4 | 734.4 |
| 18 | SEG6 | -239.85 | -734.4 | 46 | SEG33 | 239.4 | 734.4 |
| 19 | SEG7 | -154.85 | -734.4 | 47 | SEG34 | 154.4 | 734.4 |
| 20 | SEG8 | -69.85 | -734.4 | 48 | SEG35 | 69.4 | 734.4 |
| 21 | SEG9 | 15.15 | -734.4 | 49 | SEG36 | -15.6 | 734.4 |
| 22 | SEG10 | 100.15 | -734.4 | 50 | SEG37 | -100.6 | 734.4 |
| 23 | SEG11 | 185.15 | -734.4 | 51 | SEG38 | -185.6 | 734.4 |
| 24 | N.C. | 70.747 | -239.021 | 52 | SEG39 | -270.6 | 734.4 |
| 25 | SEG12 | 270.15 | -734.4 | 53 | SEG40 | -355.6 | 734.4 |
| 26 | SEG13 | 355.15 | -734.4 | 54 | SEG41 | -440.6 | 734.4 |
| 27 | SEG14 | 440.15 | -734.4 | 55 | SEG42 | -525.6 | 734.4 |
| 28 | SEG15 | 525.15 | -734.4 | 56 | SEG43 | -610.6 | 734.4 |

Note: The *COM1 and *COM2 pins are not in sequential order.

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Pad Assignment for COG



Note:

| | ge Adjustment Command | VLCD (DAD44) | Segment43 | Note | | |
|--------|--------------------------|-----------------|-----------|--|--|--|
| DE Bit | VE Bit | (PAD14) | (PAD5) | | | |
| 0 | 0 | Input | Null | The VLCD input voltage can be smaller than or equal to VDD | | |
| 0 | 1 | Output | Null | The VLCD pin is an output pin of which the voltage can be detected by the external MCU host. | | |
| 1 | 0 | Null | Output | _ | | |
| 1 | 1 | Null | Output | _ | | |

Pad Dimensions for COG

| Item | Nun | - hau | Si | ze | Unit | |
|----------------|------------|------------|------|-----|------|--|
| item | Nun | iber | X | Y | Unit | |
| Chip size | _ | _ | 2666 | 948 | μm | |
| Chip thickness | _ | _ | 50 | 08 | μm | |
| Dad nitah | 1~7, 2 | 27~73 | 6 | 0 | μm | |
| Pad pitch | 9~ | 25 | 8 | μm | | |
| | Output pad | 34~73 | 40 | 60 | μm | |
| | Output pad | 2~5, 29~32 | 60 | 40 | μm | |
| Pump size | Input pad | 10~14 | 67 | 67 | μm | |
| Bump size | | 1, 33 | 40 | 60 | μm | |
| | Dummy pad | 6~7, 27~28 | 60 | 40 | μm | |
| | | 9, 15~25 | 67 | 67 | μm | |
| Bump height | All | pad | 18 | ±3 | μm | |

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Alignment Mark Dimensions for COG

| Item | Number | Size | Unit |
|---------|--------|---|------|
| ALIGN_A | 8 | (-1237.5, -285) 10µm 20µm 40µm 40µm | μm |
| ALIGN_B | 26 | (1237.5, -285) 10μm 20μm 40μm 20μm 20μm 20μm | μm |

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Pad Coordinates for COG

Unit: µm

| No | Name | Х | Υ | No | Name | Х | Y |
|----|-------|---------|---------|----|-------|-------|-------|
| 1 | DUMMY | -1230 | 379 .5 | 39 | SEG5 | 870 | 379.5 |
| 2 | SEG40 | -1238.5 | 86.25 | 40 | SEG6 | 810 | 379.5 |
| 3 | SEG41 | -1238.5 | 26.25 | 41 | SEG7 | 750 | 379.5 |
| 4 | SEG42 | -1238.5 | -33.75 | 42 | SEG8 | 690 | 379.5 |
| 5 | SEG43 | -1238.5 | -93.75 | 43 | SEG9 | 630 | 379.5 |
| 6 | DUMMY | -1238.5 | -153.75 | 44 | SEG10 | 570 | 379.5 |
| 7 | DUMMY | -1238.5 | -213.75 | 45 | SEG11 | 510 | 379.5 |
| 9 | DUMMY | -1235 | -370.4 | 46 | SEG12 | 450 | 379.5 |
| 10 | SDA | -933 | -370.4 | 47 | SEG13 | 390 | 379.5 |
| 11 | SCL | -846 | -370.4 | 48 | SEG14 | 330 | 379.5 |
| 12 | VDD | -575 | -370.4 | 49 | SEG15 | 270 | 379.5 |
| 13 | VSS | -488 | -370.4 | 50 | SEG16 | 210 | 379.5 |
| 14 | VLCD | -300 | -370.4 | 51 | SEG17 | 150 | 379.5 |
| 15 | DUMMY | 365 | -370.4 | 52 | SEG18 | 90 | 379.5 |
| 16 | DUMMY | 452 | -370.4 | 53 | SEG19 | 30 | 379.5 |
| 17 | DUMMY | 539 | -370.4 | 54 | SEG20 | -30 | 379.5 |
| 18 | DUMMY | 626 | -370.4 | 55 | SEG21 | -90 | 379.5 |
| 19 | DUMMY | 713 | -370.4 | 56 | SEG22 | -150 | 379.5 |
| 20 | DUMMY | 800 | -370.4 | 57 | SEG23 | -210 | 379.5 |
| 21 | DUMMY | 887 | -370.4 | 58 | SEG24 | -270 | 379.5 |
| 22 | DUMMY | 974 | -370.4 | 59 | SEG25 | -330 | 379.5 |
| 23 | DUMMY | 1061 | -370.4 | 60 | SEG26 | -390 | 379.5 |
| 24 | DUMMY | 1148 | -370.4 | 61 | SEG27 | -450 | 379.5 |
| 25 | DUMMY | 1235 | -370.4 | 62 | SEG28 | -510 | 379.5 |
| 27 | DUMMY | 1238.5 | -213.75 | 63 | SEG29 | -570 | 379.5 |
| 28 | DUMMY | 1238.5 | -153.75 | 64 | SEG30 | -630 | 379.5 |
| 29 | COM0 | 1238.5 | -93.75 | 65 | SEG31 | -690 | 379.5 |
| 30 | COM1 | 1238.5 | -33.75 | 66 | SEG32 | -750 | 379.5 |
| 31 | COM2 | 1238.5 | 26.25 | 67 | SEG33 | -810 | 379.5 |
| 32 | COM3 | 1238.5 | 86.25 | 68 | SEG34 | -870 | 379.5 |
| 33 | DUMMY | 1230 | 379.5 | 69 | SEG35 | -930 | 379.5 |
| 34 | SEG0 | 1170 | 379.5 | 70 | SEG36 | -990 | 379.5 |
| 35 | SEG1 | 1110 | 379.5 | 71 | SEG37 | -1050 | 379.5 |
| 36 | SEG2 | 1050 | 379.5 | 72 | SEG38 | -1110 | 379.5 |
| 37 | SEG3 | 990 | 379.5 | 73 | SEG39 | -1170 | 379.5 |
| 38 | SEG4 | 930 | 379.5 | | | | |

Alignment Mark Coordinates for COG

| No | Name | X | Υ | No | Name | X | Υ |
|----|---------|---------|------|----|---------|--------|------|
| 8 | ALIGN A | -1237.5 | -285 | 26 | ALIGN B | 1237.5 | -285 |

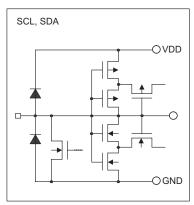
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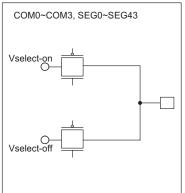


Pin Description

| Pin Name | Туре | Description |
|------------|------|--|
| SDA | I/O | Serial Data Input/Output for I ² C interface |
| SCL | I | Serial Clock Input for I ² C |
| VDD | _ | Positive power supply. |
| vss | _ | Negative power supply , ground. |
| VLCD | _ | One external resistor is connected between the VLCD pin and the VDD pin to determine the bias voltage for package with a VLCD pin. Internal voltage adjustment function is disabled. Internal voltage adjustment function can be used to adjust the VLCD voltage. If the VLCD pin is used as voltage detection pin, an external power supply should not be applied to the VLCD pin. |
| | | An external MCU can detect the voltage of the VLCD pin and program the internal voltage adjustment for packages with a VLCD pin. |
| COM0~COM3 | 0 | LCD Common outputs. |
| SEG0~SEG43 | 0 | LCD Segment outputs. |

Approximate Internal Connections





Absolute Maximum Ratings

| Supply Voltage | VSS-0.3V to VSS+6.5V | Storage Temperature | −55°C to 150°C |
|----------------|----------------------|-----------------------|----------------|
| Input Voltage | VSS-0.3V to VDD+0.3V | Operating Temperature | 40°C to 85°C |

Note: These are stress ratings only. Stresses exceeding the range specified under "Absolute Maximum Ratings" may cause substantial damage to the device. Functional operation of this device at other conditions beyond those listed in the specification is not implied and prolonged exposure to extreme conditions may affect device reliability.

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D.C. Characteristics

VSS = 0 V; VDD = 2.4V to 5.5V; Ta = -40 to +85°C

| Symbol | Davamatar | | Test Conditions | Min | Turn | May | Unit |
|------------------|--|------------------------|--|--------------------|------|--------------------|------|
| Symbol | Parameter | V _{DD} | Conditions | Min. | Тур. | Max. | Unit |
| V _{DD} | Operating Voltage | _ | _ | 2.4 | _ | 5.5 | V |
| V _{LCD} | Operating Voltage | _ | _ | _ | _ | V _{DD} | V |
| ı | Operating Current | 3V | No load, V _{LCD} =V _{DD} , 1/3bias f _{LCD} =80Hz, LCD display on, | _ | 18 | 27 | μA |
| I _{DD} | Operating Current | 5V | Internal system oscillator on,. | | 25 | 40 | μΑ |
| | Operating Current | 3V | No load, V _{LCD} =V _{DD} , 1/3bias f _{LCD} =80Hz, LCD display off, | _ | 2 | 5 | μΑ |
| DD1 | Operating Current | 5V | Internal system oscillator on, DA0~DA3 are set to "0000" | _ | 4 | 10 | μΑ |
| | Ctandby Current | 3V | No load, V _{LCD} =V _{DD} , LCD display | _ | _ | 1 | μΑ |
| I _{STB} | Standby Current | 5V | off, Internal system oscillator off, | _ | _ | 2 | μΑ |
| V _{IH} | Input Low Voltage | _ | SDA, SCL | 0.7V _{DD} | _ | V _{DD} | V |
| V _{IL} | Input Low Voltage for SDA and SCL Pins | _ | _ | 0 | _ | 0.3V _{DD} | V |
| I _{IL} | Input Leakage Current | _ | V _{IN} =V _{SS} or V _{DD} | -1 | _ | 1 | μA |
| ı | Low Level Output Current | 3V | -V₀∟=0.4V on SDA pin | 3 | _ | _ | mA |
| I _{OL} | Low Level Output Current | 5V | V _{OL} -0.4V OII SDA pili | 6 | _ | _ | mA |
| | LCD Common Sink Current | 3V | V _{LCD} =3V, V _{OL} =0.3V | 250 | 400 | _ | μA |
| I _{OL1} | LCD Common Sink Current | 5V | V _{LCD} =5V, V _{OL} =0.5V | 500 | 800 | _ | μΑ |
| | 1.00.0 | 3V | V _{LCD} =3V, V _{OH} =2.7V | -140 | -230 | _ | μΑ |
| I _{OH1} | LCD Common Source Current | 5V | V _{LCD} =5V, V _{OH} =4.5V | -300 | -500 | _ | μΑ |
| | LCD Commant Sink Commant | 3V | V _{LCD} =3V, V _{OL} =0.3V | 250 | 400 | _ | μΑ |
| I _{OL2} | LCD Segment Sink Current | 5V | V _{LCD} =5V, V _{OL} =0.5V | 500 | 800 | _ | μΑ |
| | LCD Segment Source Current | 3V | V _{LCD} =3V, V _{OH} =2.7V | -140 | -230 | _ | μA |
| I _{OH2} | LCD Segment Source Current | 5V | V _{LCD} =5V, V _{OH} =4.5V | -300 | -500 | _ | μΑ |

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A.C. Characteristics

 $V_{SS} = 0 \text{ V}$; $V_{DD} = 2.4 \text{ to } 5.5 \text{ V}$; $Ta = -40 \text{ to } +85^{\circ}\text{C}$

| Cumbal | Parameter | | Test Conditions | Min. | Tim | Max. | Unit |
|-------------------|---------------------------|------------------------|---|---------|------|--------|------|
| Symbol | Parameter | V _{DD} | Conditions | IVIIII. | Тур. | IVIAX. | Unit |
| f _{LCD1} | LCD Frame Frequency | 4V | 1/4 duty, T _a =25°C | 72 | 80 | 88 | Hz |
| f _{LCD2} | LCD Frame Frequency | 4V | 1/4 duty, T _a = −40 to +85°C | 52 | 80 | 124 | Hz |
| f _{LCD3} | LCD Frame Frequency | 4V | 1/4 duty, Ta =25°C | 144 | 160 | 176 | Hz |
| f _{LCD4} | LCD Frame Frequency | 4V | $1/4$ duty, $T_a = -40$ to $+85$ °C | 104 | 160 | 248 | Hz |
| t _{OFF} | V _{DD} OFF Times | _ | V _{DD} drop down to 0V | 20 | _ | _ | ms |
| t _{SR} | V _{DD} Slew Rate | - | _ | 0.05 | _ | _ | V/ms |

- Note: 1. If the Power on Reset timing conditions are not satisfied during the power ON/OFF sequence, the internal Power on Reset circuit will not operate normally.
 - 2. If V_{DD} drops below the minimum voltage of operating voltage spec. during operating, the Power on Reset timing conditions must also be satisfied. That is, V_{DD} must drop to 0V and remain at 0V for 20ms (min.) before rising to its normal operating voltage.

I²C Interface

| | . | | V _{DD} =2.4 | √ to 5.5V | V _{DD} =3.0\ | | |
|---------------------|---|--|----------------------|-----------|-----------------------|------|------|
| Symbol | Parameter | Conditions | Min. | Max. | Min. | Max. | Unit |
| f _{SCL} | Clock Frequency | _ | _ | 100 | _ | 400 | kHz |
| t _{BUF} | Bus Free Time | Time in which the bus must be free before a new transmission can start | 4.7 | _ | 1.3 | _ | μs |
| t _{HD;STA} | Start Condition Hold Time | After this period, the first clock pulse is generated | 4 | _ | 0.6 | _ | μs |
| t _{LOW} | SCL Low Time | _ | 4.7 | _ | 1.3 | _ | μs |
| t _{HIGH} | SCL High Time | _ | 4 | _ | 0.6 | _ | μs |
| t _{su;sta} | Start Condition Setup Time | Only relevant for repeated START condition. | 4.7 | _ | 0.6 | _ | μs |
| t _{HD;DAT} | Data Hold Time | _ | 0 | _ | 0 | _ | ns |
| t _{SU;DAT} | Data Setup Time | _ | 250 | _ | 100 | _ | ns |
| t _R | SDA and SCL Rise Fime | Note* | _ | 1 | _ | 0.3 | μs |
| t _F | SDA and SCL Fall Time | Note* | _ | 0.3 | _ | 0.3 | μs |
| t _{su;sto} | Stop Condition set-up Time | _ | 4 | _ | 0.6 | _ | μs |
| taa | Output Valid from Clock | _ | _ | 3.5 | _ | 0.9 | μs |
| t _{SP} | Input Filter Time Constant (SDA and SCL Pins) | Noise suppression time | _ | 100 | _ | 50 | ns |

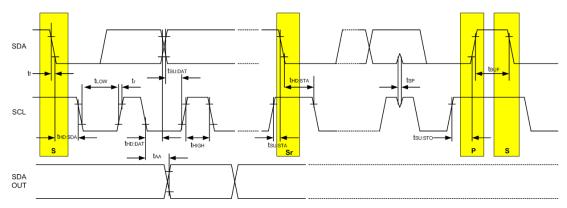
Note: These parameters are periodically sampled but not 100% tested.

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Timing Diagrams

I²C Timing



Note: The write cycle time t_{WR} is the time from a valid stop condition of a write sequence to the end of the valid start condition of a sequential command.

Power On Reset Timing



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Functional Description

Power-on Reset

When power is applied, the device is initialised by an internal power-on reset circuit. The status of the internal circuits after initialisation is as follows:

- All common outputs are set to $V_{\mbox{\tiny DD}}$
- All segment outputs are set to $V_{\mbox{\tiny DD}}$
- The drive mode 1/4 duty output and 1/3 bias is selected
- The System Oscillator and the LCD bias generator is off state
- · LCD Display is off state
- · Internal voltage adjustment function is enabled
- Detection switch for $V_{\text{\tiny LCD}}$ pin is disabled
- Frame Frequency is set to 80Hz
- · Blinking function is switched off

Data transfers on the I²C-bus should be avoided for 1ms following power-on to allow completion of the reset action.

Display Memory - RAM Structure

The display RAM is a static 44×4-bit RAM which stores LCD data. Logic "1" in the RAM bit-map indicates the "on" state of the corresponding LCD segment; similarly logic 0 indicates the "off" state.

The contents of the RAM data are directly mapped to the LCD data. The first RAM column corresponds to the 44 segments operated with respect to COM0. In multiplexed LCD applications the segment data of the second, third and fourth column of the display RAM are time-multiplexed with COM1, COM2 and COM3 respectively. The following is a mapping from the RAM data to the LCD pattern:

| Output | COM3 | COM2 | COM1 | COM0 | Output | COM3 | COM2 | COM1 | COM0 | address |
|--------|------|------|------|------|--------|------|------|------|------|---------|
| SEG1 | | | | | SEG0 | | | | | 0 |
| SEG3 | | | | | SEG2 | | | | | 1 |
| SEG5 | | | | | SEG4 | | | | | 2 |
| SEG7 | | | | | SEG6 | | | | | 3 |
| SEG9 | | | | | SEG8 | | | | | 4 |
| SEG11 | | | | | SEG10 | | | | | 5 |
| | | | | | | | | | | |
| SEG43 | | | | | SEG42 | | | | | 21 |
| | D7 | D6 | D5 | D4 | | D3 | D2 | D1 | D0 | Data |

Display data transfer format for the I2C bus.

| MSE | 3 | | | | | | LSB |
|-----|----|----|----|----|----|----|-----|
| D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |

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System Oscillator

The timing for the internal logic and the LCD drive signals are generated by an internal oscillator. The System Clock frequency (fsvs) determines the LCD frame frequency. During initial system power on the System Oscillator will be in the stop state.

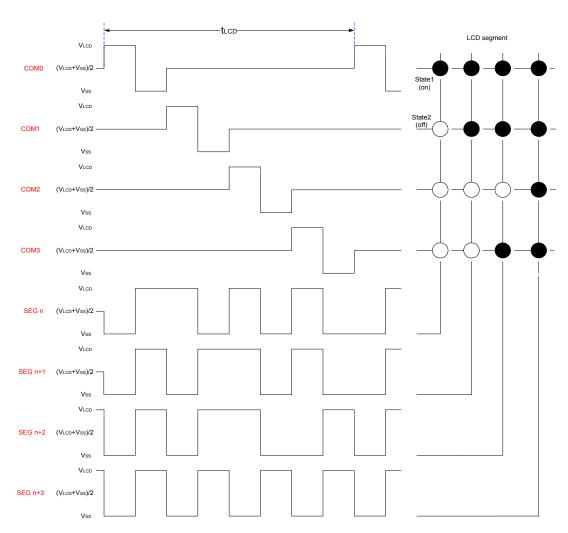
LCD Bias Generator

The full-scale LCD voltage (V_{op}) is obtained from $V_{\mbox{\tiny LCD}} - V_{\mbox{\tiny SS}}$. The LCD voltage may be temperature compensated externally through the Voltage supply to the VLCD pin.

Fractional LCD biasing voltages are obtained from an internal voltage divider of three series resistors connected between $V_{\text{\tiny LCD}}$ and $V_{\text{\tiny SS}}$. The centre resistor can be switched out of the circuits to provide a 1/2 bias voltage level for the 1/4 duty configuration.

LCD Drive Mode Waveforms

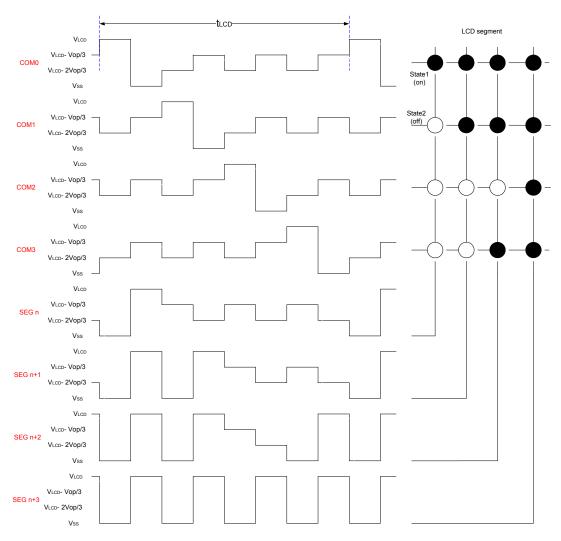
 When two columns are provided in the LCD, the 1/4duty drive mode applies. The HT16C22/ HT16C22G can use 1/2 or 1/3 bias types in output waveforms as shown as follows:



Waveforms for 1/4 Duty Drive Mode with 1/2 Bias ($V_{\text{op}}=V_{\text{LCD}}-V_{\text{SS}}$)

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Waveforms for 1/4 Duty Drive Mode with 1/3 Bias (V_{OP} = V_{LCD} - V_{SS})

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Segment Driver Outputs

The LCD drive section includes 44 segment outputs SEG0 to SEG43 which should be connected directly to the LCD panel. The segment output signals are generated in accordance with the multiplexed column signals and with the data resident in the display latch. When less than 44 segment outputs are required the unused segment outputs should be left open-circuit.

Column Driver Outputs

The LCD drive section includes four column outputs COM0 to COM3 which should be connected directly to the LCD panel. The column output signals are generated in accordance with the selected LCD drive mode. When less than 4 column outputs are required the unused column outputs should be left open-circuit.

Address Pointer

The addressing mechanism for the display RAM is implemented using the address pointer. This allows the loading of an individual display data byte, or a series of display data bytes, into any location of the display RAM. The sequence commences with the initialisation of the address pointer by the Address pointer command.

Blinker Function

The device contains versatile blinking capabilities. The whole display can be blinked at frequency selected by the Blink command. The blinking frequency is a subdivided ratio of the system frequency. The ratio between the system oscillator and blinking frequency depends on the blinking mode in which the device is operating in, as shown in the table:

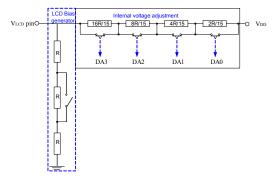
| Blinking Mode | Operating Mode Ratio | Blinking Frequency (Hz) |
|------------------|----------------------|----------------------------|
| 0 | 0 | Blink off |
| 1 | fsys/ 16384HZ | 2 |
| 2 | fsys / 32768HZ | 1 |
| 3 | fsys / 65536HZ | 0.5 |

Frame Frequency

The HT16C22/HT16C22G provides two frame frequencies selected with the Mode set command; 80Hz and 160Hz.

V_{LCD} Voltage Adjustment

 The internal V_{LCD} adjustment contains four resistors in series and a 4- bit programmable analog switch which can provide sixteen voltage adjustment options using the VLCD voltage adjustment command. • The $V_{\text{\tiny LCD}}$ adjustment structure is show in the diagram:



 The relationship between the programmable 4-bit analog switch and the V_{LCD} output voltage is shown in the table:

| DA3~ | | Bias | | | | | | | |
|------|------------------------|-----------------------|---------------|--|--|--|--|--|--|
| DA0 | 1/2 | 1/3 | Note | | | | | | |
| 00H | 1.000*V _{DD} | 1.000*V _{DD} | Default value | | | | | | |
| 01H | 0.9375*V _{DD} | 0.957*V _{DD} | _ | | | | | | |
| 02H | 0.882*V _{DD} | 0.918*V _{DD} | _ | | | | | | |
| 03H | 0.833*V _{DD} | 0.882*V _{DD} | _ | | | | | | |
| 04H | 0.789*V _{DD} | 0.849*V _{DD} | _ | | | | | | |
| 05H | 0.750*V _{DD} | 0.818*V _{DD} | _ | | | | | | |
| 06H | 0.714*V _{DD} | 0.789*V _{DD} | _ | | | | | | |
| 07H | 0.682*V _{DD} | 0.763*V _{DD} | _ | | | | | | |
| 08H | 0.652*V _{DD} | 0.738*V _{DD} | _ | | | | | | |
| 09H | 0.625*V _{DD} | 0.714*V _{DD} | _ | | | | | | |
| 0AH | 0.600*V _{DD} | 0.692*V _{DD} | _ | | | | | | |
| 0BH | 0.577*V _{DD} | 0.672*V _{DD} | _ | | | | | | |
| 0CH | 0.556*V _{DD} | 0.652*V _{DD} | _ | | | | | | |
| 0DH | 0.536*V _{DD} | 0.634*V _{DD} | _ | | | | | | |
| 0EH | 0.517*V _{DD} | 0.616*V _{DD} | _ | | | | | | |
| 0FH | 0.500*V _{DD} | 0.600*V _{DD} | _ | | | | | | |

I²C Serial Interface

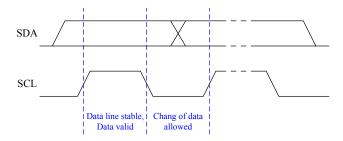
The device includes an I²C serial interface. The I²C bus is for bidirectional, two-line communication between different ICs or modules. The two lines are a serial data line, SDA, and a serial clock line, SCL. Both lines are connected to the positive supply via pull-up resistors with a typical value of $4.7k\Omega$. When the bus is free, both lines are high. Devices connected to the bus must have open-drain or open-collector outputs to implement a wired-or function. Data transfer is initiated only when the bus is not busy.

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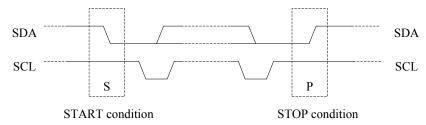
Data Validity

The data on the SDA line must be stable during the high period of the serial clock. The high or low state of the data line can only change when the clock signal on the SCL line is Low as shown in the diagram.



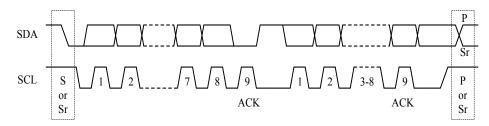
START and STOP Conditions

- A high to low transition on the SDA line while SCL is high defines a START condition
- A low to high transition on the SDA line while SCL is high defines a STOP condition
- START and STOP conditions are always generated by the master. The bus is considered to be busy after the START condition. The bus is considered to be free again a certain time after the STOP condition.
- The bus stays busy if a repeated START (Sr) is generated instead of a STOP condition. In some respects, the START(S) and repeated START (Sr) conditions are functionally identical.



Byte Format

Every byte placed on the SDA line must be 8-bits in length. The number of bytes that can be transmitted per transfer is unrestricted. Each byte has to be followed by an acknowledge bit. Data is transferred with the most significant bit, MSB, first.

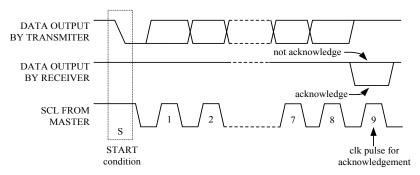


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Acknowledge

- Each byte of eight bits is followed by one acknowledge bit. The acknowledge bit is a low level placed on the bus by the receiver. The master generates an extra acknowledge related clock pulse.
- · A slave receiver which is addressed must generate an acknowledge bit, ACK, after the reception of each byte.
- The device that acknowledges must pull down the SDA line during the acknowledge clock pulse so that it remains stable low during the high period of this clock pulse
- A master receiver must signal an end of data to the slave by generating a not-acknowledge, NACK, bit on the
 ast byte that has been clocked out of the slave. In this case, the master receiver must leave the data line high
 during the 9th pulse to not acknowledge. The master will generate a STOP or repeated START condition.



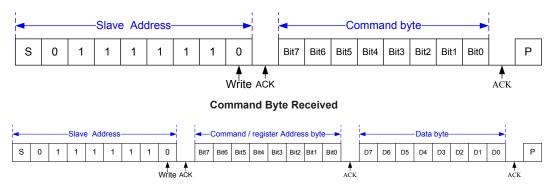
Slave Addressing

- The slave address byte is the first byte received following the START condition form the master device. The first seven bits of the first byte make up the slave address. The eighth bit defines a read or write operation to be performed. When the R/W bit is "1", a read operation is selected. A "0" selects a write operation.
- The HT16C22/HT16C22G address bits are "0111111". When an address byte is sent, the device compares the first seven bits after the START condition. If they match, the device outputs an acknowledge on the SDA line.



Byte Write Operation

A byte write operation requires a START condition, a slave address with an R/\overline{W} bit, a valid Register Address, Data and a STOP condition. After each of the three bytes, the device responds with an ACK.



Single Data Byte Received

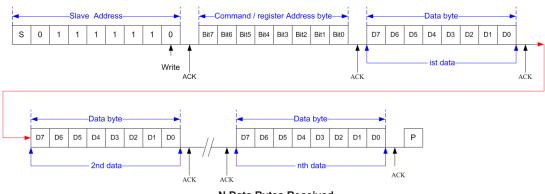
Note: If the byte following the slave address is a command code, the byte following the command code will be ignored.

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Page Write Operation

After a START condition the slave address with the R/\overline{W} bit is placed on the bus followed with the Register Address of which the contents are written to the internal address pointer. The data to be written to the memory will be transmitted next and then the internal address pointer will be incremented by 1 to indicate the next memory address location after the reception of an acknowledge clock. After the internal address point reaches the maximum memory address, which is 15H, the address pointer will be reset to 00H.

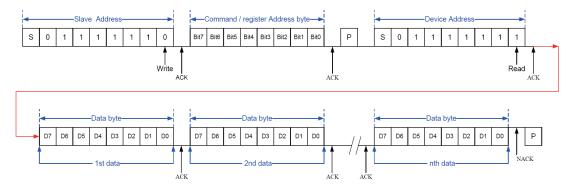


N Data Bytes Received

Read Operation

In this mode, the master reads the HT16C22/HT16C22G data after setting the slave address. Following the R/W bit (='0") is an acknowledge bit and the Register Address (An) which is written to the internal address pointer. After the start address of the Read Operation has been configured, another START condition and the slave address are transferred on the bus followed by the R/W bit (='1"). Then the MSB of the data which was addressed is transmitted first on the I²C bus. The address pointer is only incremented by 1 after the reception of an acknowledge clock. That means that if the device is configured to transmit the data at the address of An+1, the master will read and acknowledge the transferred new data byte and the internal address pointer is incremented to An+2. After the internal address pointer reaches the maximum memory address which is 15h, the pointer will be reset to 00h.

This cycle of reading consecutive addresses will continue until the master sends a STOP condition.



Reading N Data Bytes

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Command Summary

LCD Driver Mode Set

These commands set the frame frequency output and internal system oscillator on/off and display on/off and driver mode set.

| | MSB | | | | | | | LSB | | |
|----------|------|------|------|------|------|------|------|------|------|-----|
| Function | Bit7 | Bit6 | Bit5 | Bit4 | Bit3 | Bit2 | Bit1 | Bit0 | Note | Def |
| Mode set | 1 | 0 | 0 | F | S | E | 0 | МО | | 80H |

Note: 1. When "M0" is set to "0":

The driver mode is set to 1/3bias.

2. When "M0" is set to "1":

The driver mode is set to 1/2bias.

3. When "S" and "E" bits are set to $\{0, X\}$:

Display off and disable Internal System oscillator.

4. When "S" and "E" bits are set to {1, 0}:

Display off and enable Internal System oscillator.

5. When "S" and "E" bits are set to {1, 1}:

Display on and enable Internal System oscillator.

6. When "F" bits is set to "0":

Frame Frequency=80Hz

7. When "F" bits is set to "1":

Frame Frequency=160Hz

8. Power on status:

The drive mode 1/3 bias is selected

Display off and disable Internal System oscillator

Frame frequency is set to 80Hz

9. If programmed command data is not defined, the function will not be affected.

Display Data Input Setting

This command sends data from MCU to memory MAP of HT16C22/HT16C22G.

| | MSB | | | | | | | LSB | | |
|-----------------|------|------|------|------|------|------|------|------|--|-----|
| Function | Bit7 | Bit6 | Bit5 | Bit4 | Bit3 | Bit2 | Bit1 | Bit0 | Note | Def |
| Address pointer | 0 | 0 | 0 | A4 | А3 | A2 | A1 | A0 | Display data start address of memory map | 00H |

Note: 1. Power on status: the address is set to 00H.

- 2. After reaching the memory location 15h, the pointer will reset to 00h.
- 3. If programmed command data is not defined, the function will not be affected.



Blinking Setting Command

These commands set the blinking frequency of display modes.

| | MSB | | | | | | | LSB | | |
|--------------------|------|------|------|------|------|------|------|------|------|-----|
| Function | Bit7 | Bit6 | Bit5 | Bit4 | Bit3 | Bit2 | Bit1 | Bit0 | Note | Def |
| Blinking Frequency | 1 | 1 | 0 | 0 | 0 | 0 | BK1 | вко | | СОН |

Note: 1. When "BK1" and "BK0" bits are set to $\{0, 0\}$:

Blinking off

2. When "BK1" and "BK0" bits are set to $\{0, 1\}$:

Blinking Frequency= 2Hz

3. When "BK1" and "BK0" bits are set to {1, 0}:

Blinking Frequency= 1Hz

4. When "BK1" and "BK0" bits are set to {1, 1}:

Blinking Frequency= 0.5Hz

5. Power on status: Blinking is switched off.

6. If programmed command data is not defined, the function will not be affected.

Internal Voltage Adjustment (IVA) Setting Command

The internal voltage (V_{LCD}) adjustment can provide sixteen kinds of regulator voltage adjustment options by setting LCD operating voltage adjustment command code.

| | MSB | | | | | | | LSB | | |
|-----------------------------------|------|------|------|------|------|------|------|------|--|-----|
| Function | Bit7 | Bit6 | Bit5 | Bit4 | Bit3 | Bit2 | Bit1 | Bit0 | Note | Def |
| Internal Voltag Adjust control | e 0 | 1 | DE | VE | DA3 | DA2 | DA1 | DA0 | The Segment/ VLCD shared pin can be programmed via the "DE" bit The "VE" bit is used to enable or disable the internal voltage adjustment for bias voltage. DA3~DA0 can be used to adjust the VLCD output voltage. | 70H |

Note: 1. When "DE" and "VE" bits are set to $\{0, 0\}$:

The Segment/ VLCD shared pin is set as VLCD pin.

Disable internal voltage adjustment.

One external resister must be connected between VLCD pin and VDD pin to determine the bias voltage, and internal voltage follower (OP3) must be enabled by setting DA3~DA0 as the value other than "0000". If VLCD pin is connected to VDD pin, the internal voltage follower (OP3) must be disabled by setting DA3~DA0 as "0000".

2. When "DE" and "VE" bits are set to $\{0,1\}$:

The Segment/ VLCD shared pin is set as VLCD pin.

Enable internal voltage adjustment.

The external MCU can detect the voltage of VLCD pin.

3. When "DE" and "VE" bits are set to {1,0}:

The Segment/VLCD shared pin is set as Segment pin.

Disable internal voltage adjustment.

The bias voltage is supplied by internal VDD power.

The internal voltage-follower (OP3) is disabled automatically when DE & VE is set as "10". DA3~DA0 don't care.

4. When "DE" and "VE" bits are set to {1,1}:

The Segment/ VLCD shared pin is set as Segment pin.

Enable internal voltage adjustment.

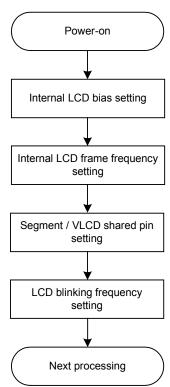
- 5. When DA0~DA3 bits are set to "0000", internal voltage-follower (OP3) is disabled. When DA0~DA3 bits are set to other values, internal voltage follower (OP3) is enabled.
- 6. Power output status: Enable internal voltage adjustment and Segment/VLCD pin is set as the Segment pin.
- 7. If programmed command data is not defined, the function will not be affected.



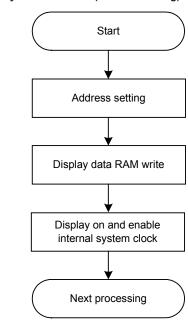
Operation FlowChart

Access procedures are illustrated below by means of flowcharts.

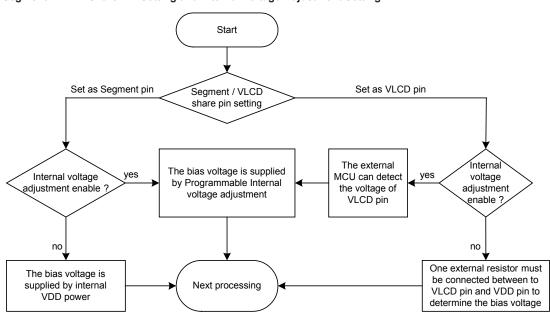
Initialization



Display data read/write(address setting)



Segment / VLCD Share Pin Setting and Internal Voltage Adjustment Setting



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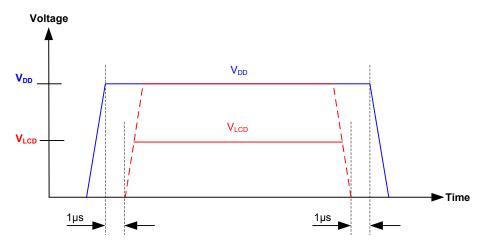


Power Supply Sequence

- If the power is individually supplied on the LCD and VDD pins, it is strongly recommended to follow the Holtek power supply sequence requirement.
- If the power supply sequence requirement is not followed, it may result in malfunction.

Holtek Power Supply Sequence Requirement:

- 1. Power-on sequence: $Turn \ on \ the \ logic \ power \ supply \ V_{DD} \ first \ and \ then \ turn \ on \ the \ LCD \ driver \ power \ supply \ V_{LCD}.$
- 2. Power-off sequence: Turn off the LCD driver power supply V_{LCD} . First and then turn off the logic power supply V_{DD} .
- 3. The Holtek Power Supply Sequence Requirement must be followed no matter whether the V_{LCD} voltage is higher than the V_{DD} voltage.
- When the V_{LCD} voltage is smaller than or is equal to V_{DD} voltage application



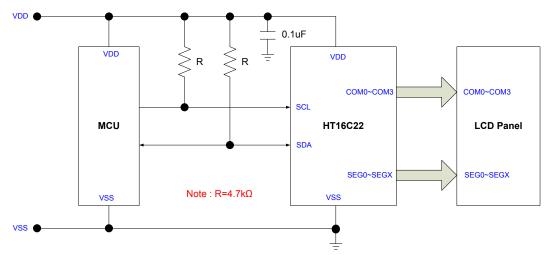
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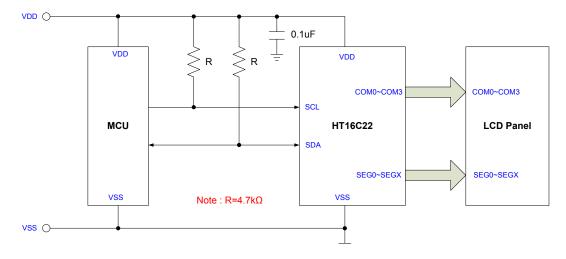
Application Circuit

Set as Segment Pin

- 1. Disable internal voltage adjustment
- 2. The bias voltage is supplied by internal VDD power.



- 3. Enable internal voltage
- 4. The internal voltage adjustment for bias voltage

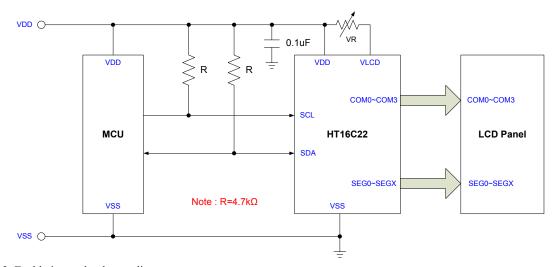


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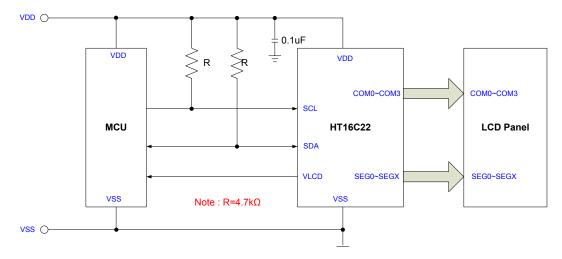


Set as VLCD Pin

- 1. Disable internal voltage adjustment
- 2. One external resister must be connected between VLCD pin and VDD pin to determine the bias voltage



- 3. Enable internal voltage adjustment
- 4. The external MCU can detect the voltage of VLCD pin.



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Package Information

Note that the package information provided here is for consultation purposes only. As this information may be updated at regular intervals users are reminded to consult the <u>Holtek website</u> for the latest version of the package information.

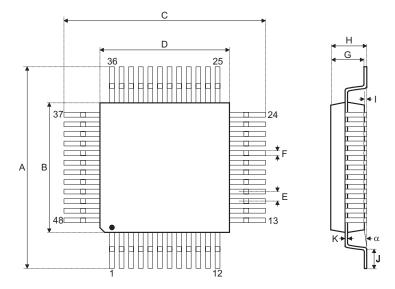
Additional supplementary information with regard to packaging is listed below. Click on the relevant section to be transferred to the relevant website page.

- Further Package Information (include Outline Dimensions, Product Tape and Reel Specifications)
- Packing Meterials Information
- Carton information

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48-pin LQFP (7mm×7mm) Outline Dimensions



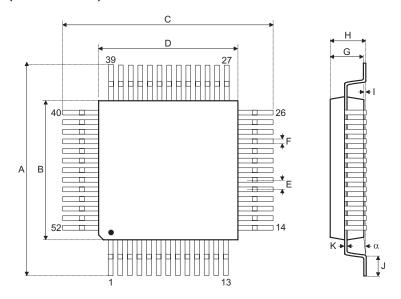
| Symbol | Dimensions in inch | | | | | | | |
|--------|--------------------|-----------|-------|--|--|--|--|--|
| Зушьог | Min. | Nom. | Max. | | | | | |
| Α | _ | 0.354 BSC | _ | | | | | |
| В | _ | 0.276 BSC | _ | | | | | |
| С | _ | 0.354 BSC | _ | | | | | |
| D | _ | 0.276 BSC | _ | | | | | |
| E | _ | 0.020 BSC | _ | | | | | |
| F | 0.007 | 0.009 | 0.011 | | | | | |
| G | 0.053 | 0.055 | 0.057 | | | | | |
| Н | _ | _ | 0.063 | | | | | |
| I | 0.002 | _ | 0.006 | | | | | |
| J | 0.018 | 0.024 | 0.030 | | | | | |
| K | 0.004 | _ | 0.008 | | | | | |
| α | 0° | _ | 7° | | | | | |

| Cumbal | | Dimensions in mm | | | | | | | | |
|--------|------|------------------|------|--|--|--|--|--|--|--|
| Symbol | Min. | Nom. | Max. | | | | | | | |
| А | _ | 9.00 BSC | _ | | | | | | | |
| В | _ | 7.00 BSC | _ | | | | | | | |
| С | _ | 9.00 BSC | _ | | | | | | | |
| D | _ | 7.00 BSC | _ | | | | | | | |
| E | _ | 0.50 BSC | _ | | | | | | | |
| F | 0.17 | 0.22 | 0.27 | | | | | | | |
| G | 1.35 | 1.40 | 1.45 | | | | | | | |
| Н | _ | _ | 1.60 | | | | | | | |
| 1 | 0.05 | _ | 0.15 | | | | | | | |
| J | 0.45 | 0.60 | 0.75 | | | | | | | |
| K | 0.09 | _ | 0.20 | | | | | | | |
| α | 0° | _ | 7° | | | | | | | |

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52-pin LQFP (14mm×14mm) Outline Dimensions



| Symbol | | Dimensions in inch | |
|--------|-------|--------------------|-------|
| Symbol | Min. | Nom. | Max. |
| A | 0.622 | 0.630 | 0.638 |
| В | 0.547 | 0.551 | 0.555 |
| С | 0.622 | 0.630 | 0.638 |
| D | 0.547 | 0.551 | 0.555 |
| Е | _ | 0.039 BSC | _ |
| F | 0.015 | _ | 0.019 |
| G | 0.053 | 0.055 | 0.057 |
| Н | _ | _ | 0.063 |
| I | 0.002 | _ | 0.008 |
| J | 0.018 | _ | 0.030 |
| K | 0.005 | _ | 0.007 |
| α | 0° | _ | 7° |

| Symbol | | Dimensions in mm | |
|--------|-------|------------------|-------|
| Symbol | Min. | Nom. | Max. |
| A | 15.80 | 16.00 | 16.20 |
| В | 13.90 | 14.00 | 14.10 |
| С | 15.80 | 16.00 | 16.20 |
| D | 13.90 | 14.00 | 14.10 |
| E | _ | 1.00 BSC | _ |
| F | 0.39 | _ | 0.48 |
| G | 1.35 | 1.40 | 1.45 |
| Н | _ | _ | 1.60 |
| I | 0.05 | _ | 0.20 |
| J | 0.45 | _ | 0.75 |
| K | 0.13 | _ | 0.18 |
| α | 0° | _ | 7° |

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